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- Control Inputs VIH/VIL Levels Are Referenced to V_{CCA} Voltage
- V_{CC} Isolation Feature If Either V_{CC} Input Is at GND, All Outputs Are in the **High-Impedance State**
- Overvoltage-Tolerant Inputs/Outputs Allow Mixed-Voltage-Mode Data Communications
- **Fully Configurable Dual-Rail Design Allows** Each Port to Operate Over the Full 1.2-V to 3.6-V Power-Supply Range
- Ioff Supports Partial-Power-Down Mode Operation

- I/Os Are 4.6-V Tolerant
- Bus Hold on Data Inputs Eliminates the **Need for External Pullup/Pulldown** Resistors
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- **ESD Protection Exceeds JESD 22**
 - 8000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

description/ordering information

This 24-bit noninverting bus transceiver uses two separate configurable power-supply rails. The SN74AVCH24T245 is optimized to operate with V_{CCA}/V_{CCB} set at 1.4 V to 3.6 V. It is operational with V_{CCA}/V_{CCB} as low as 1.2 V. The A port is designed to track V_{CCA}. V_{CCA} accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track V_{CCB}. V_{CCB} accepts any supply voltage from 1.2 V to 3.6 V. This allows for universal low-voltage bidirectional translation between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

The SN74AVCH24T245 is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the outputs so the buses are effectively isolated.

The SN74AVCH24T245 is designed so that the control pins (1DIR, 2DIR, 3DIR, 4DIR, 5DIR, 6DIR, 1OE, 2OE, $3\overline{OE}$, $4\overline{OE}$, $5\overline{OE}$, and $6\overline{OE}$) are supplied by V_{CCA} .

This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The V_{CC} isolation feature ensures that if either V_{CC} input is at GND, then both ports are in the high-impedance state.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

To ensure the high-impedance state during power up or power down, $\overline{\text{OE}}$ should be tied to V_{CCA} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

ORDERING INFORMATION

TA	PACKAGET		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	LFBGA – GRG	Tone and real	74AVCH24T245GRGR	WL245
-40°C to 85°C	LFBGA – ZRG (Pb-free)	Tape and reel	74AVCH24T245ZRGR	VVL245

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



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GRG OR ZRG PACKAGE (TOP VIEW)

		1	2	3	4	5	6	
Α	/	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	
В		\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	
С		\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	
D		\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	
Е		\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	
F		\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	
G		\bigcirc	\bigcirc		\bigcirc	\bigcirc	\bigcirc	
Н		_	\bigcirc	_	_	_	_	
J		_	\bigcirc	_	_	_	_	
K		_	\bigcirc	_	_	_	_	
L		_	\bigcirc	_	_	_	_	
M		_	\bigcirc	_	_	_	_	
N		_	\bigcirc	_	_	_	_	
Р		\bigcirc	\bigcirc	\bigcirc	\bigcirc	()	\bigcirc	J

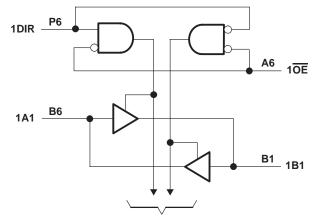
terminal assignments

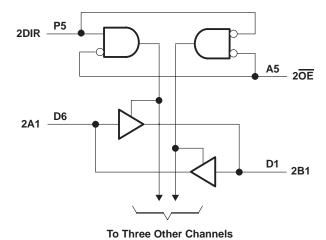
	1	2	3	4	5	6
Α	6OE	5OE	4OE	3OE	2OE	1 <mark>OE</mark>
В	1B1	1B2	VCCB	VCCA	1A2	1A1
С	1B3	1B4	GND	GND	1A4	1A3
D	2B1	2B2	VCCB	VCCA	2A2	2A1
E	2B3	2B4	GND	GND	2A4	2A3
F	3B1	3B2	GND	GND	3A2	3A1
G	3B3	3B4		GND	3A4	3A3
Н	4B1	4B2	VCCB	VCCA	4A2	4A1
J	4B3	4B4	GND	GND	4A4	4A3
K	5B1	5B2	GND	GND	5A2	5A1
L	5B3	5B4	VCCB	VCCA	5A4	5A3
M	6B1	6B2	GND	GND	6A2	6A1
N	6B3	6B4	VCCB	VCCA	6A4	6A3
Р	6DIR	5DIR	4DIR	3DIR	2DIR	1DIR

FUNCTION TABLE (each 4-bit section)

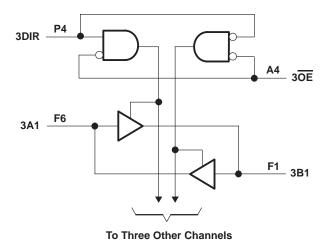
INP	UTS						
OE	DIR	OPERATION					
L	L	B data to A bus					
L	Н	A data to B bus					
Н	X	Isolation					

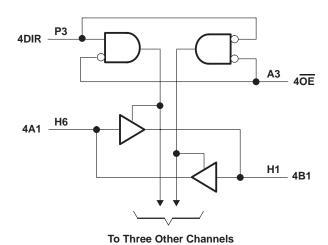
logic diagram (positive logic)

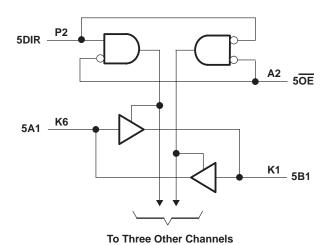


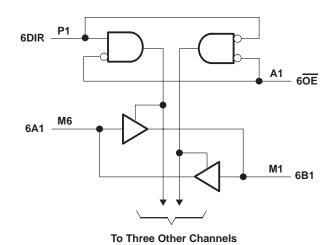


To Three Other Channels









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absolute maximum ratings	over operating free-ai	ir temperature range	(unless otherwise noted)†
absolute maximum ratings	over operating nec-a	ii teiliperature range	(unicoo oliici wioc nolcu)

Supply voltage range, V _{CCA} and V _{CCB}	0.5 V to 4.6 V 0.5 V to 4.6 V
Voltage range applied to any output in the high-impedance or power-off state, VO	
(see Note 1): A port	–0.5 V to 4.6 V
B port	–0.5 V to 4.6 V
Voltage range applied to any output in the high or low state, VO	
(see Notes 1 and 2): A port	. $-0.5 \text{ V to V}_{CCA} + 0.5 \text{ V}$
B port	. $-0.5 \text{ V to V}_{CCB} + 0.5 \text{ V}$
Input clamp current, I _{IK} (V _I < 0)	
Output clamp current, I_{OK} ($V_O < 0$)	
Continuous output current, I _O	
Continuous current through each V _{CCA} , V _{CCB} , and GND	
Package thermal impedance, θ _{JA} (see Note 3): GRG/ZRG package	
Storage temperature range, T _{Stq}	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
 - 2. The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.
 - 3. The package thermal impedance is calculated in accordance with JESD 51-7.



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recommended operating conditions (see Notes 4 through 6)

			VCCI	VCCO	MIN	MAX	UNIT
VCCA	Supply voltage				1.2	3.6	V
V _{CCB}	Supply voltage				1.2	3.6	V
			1.2 V to 1.95 V		V _{CCI} × 0.65		
VIH	High-level input voltage	Data inputs (see Note 7)	1.95 V to 2.7 V		1.6		V
	voltago	(300 14010 1)	2.7 V to 3.6 V		2		
			1.2 V to 1.95 V			V _{CCI} × 0.35	
٧ _{IL}	Low-level input voltage	Data inputs (see Note 7)	1.95 V to 2.7 V			0.7	V
	voltago	(000 11010 1)	2.7 V to 3.6 V			0.8	
	18.1.1.1.1.	DIR			$V_{CCA} \times 0.65$		
٧ _{IH}	High-level input voltage	(referenced to V _{CCA})	1.95 V to 2.7 V		1.6		V
	voltago	(see Note 8)	2.7 V to 3.6 V		2		
		DIR	1.2 V to 1.95 V			$V_{CCA} \times 0.35$	
V _{IL}	Low-level input voltage	(referenced to VCCA)	1.95 V to 2.7 V			0.7	V
	voltago	(see Note 8)	2.7 V to 3.6 V			0.8	
VI	Input voltage				0	3.6	V
\/-	Output voltage	Active state			0	Vcco	V
VO	Output voltage	3-state			0	3.6	V
				1.2 V		-3	
				1.4 V to 1.6 V		-6	
lон	High-level output curre	nt		1.65 V to 1.95 V		-8	mA
				2.3 V to 2.7 V		-9	
				3 V to 3.6 V		-12	
				1.2 V		3	
				1.4 V to 1.6 V		6	
lOL	Low-level output current			1.65 V to 1.95 V		8	mA
				2.3 V to 2.7 V		9	
				3 V to 3.6 V		12	
Δt/Δν	Input transition rise or f	all rate				5	ns/V
TA	Operating free-air temp	erature			-40	85	°C

NOTES: 4. $V_{\mbox{CCI}}$ is the $V_{\mbox{CC}}$ associated with the data input port.

- 5. V_{CCO} is the V_{CC} associated with the output port.
- 6. All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.
- 7. For V_{CCI} values not specified in the data sheet, V_{IH} min = V_{CCI} × 0.7 V, V_{IL} max = V_{CCI} × 0.3 V. 8. For V_{CCI} values not specified in the data sheet, V_{IH} min = V_{CCA} × 0.7 V, V_{IL} max = V_{CCA} × 0.3 V.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Note 9)

			1		T,	4 = 25°C	;	-40°C to	85°C		
PARAMETE	TEST CO	NDITIONS	VCCA	VCCB	MIN	TYP	MAX	MIN	MAX	UNIT	
	I _{OH} = -100 μ	A	1.2 V to 3.6 V	1.2 V to 3.6 V				Vcco-	0.2 V		
	$I_{OH} = -3 \text{ mA}$		1.2 V	1.2 V		0.95					
l .,	$I_{OH} = -6 \text{ mA}$		1.4 V	1.4 V				1.05		V	
VOH	$I_{OH} = -8 \text{ mA}$	V _I = V _{IH}	1.65 V	1.65 V				1.2		V	
	$I_{OH} = -9 \text{ mA}$		2.3 V	2.3 V				1.75			
	$I_{OH} = -12 \text{ m/}$	Λ.	3 V	3 V				2.3			
	$I_{OL} = 100 \mu A$		1.2 V to 3.6 V	1.2 V to 3.6 V					0.2		
	$I_{OL} = 3 \text{ mA}$		1.2 V	1.2 V		0.15					
Va.	$I_{OL} = 6 \text{ mA}$	\(\lambda_1 \) \(\lambda_1 \)	1.4 V	1.4 V					0.35	V	
VOL	$I_{OL} = 8 \text{ mA}$	V _I = V _{IL}	1.65 V	1.65 V					0.45	V	
	$I_{OL} = 9 \text{ mA}$		2.3 V	2.3 V					0.55		
	$I_{OL} = 12 \text{ mA}$		3 V	3 V					0.7		
I _I Con		GND	1.2 V to 3.6 V	1.2 V to 3.6 V		±0.025	±0.25		±1	μΑ	
	V _I = 0.42 V		1.2 V	1.2 V		25					
	$V_{I} = 0.49 V$		1.4 V	1.4 V				15			
I _{BHL} †	V _I = 0.58 V		1.65 V	1.65 V				25		μΑ	
	$V_I = 0.7 V$		2.3 V	2.3 V				45			
	V _I = 0.8 V		3.3 V	3.3 V				100			
	V _I = 0.78 V		1.2 V	1.2 V		-25					
	V _I = 0.91 V		1.4 V	1.4 V				-15			
I _{BHH} ‡	$V_{I} = 1.07 V$		1.65 V	1.65 V				-25		μΑ	
	V _I = 1.6 V		2.3 V	2.3 V				-45			
	V _I = 2 V		3.3 V	3.3 V				-100			
			1.2 V	1.2 V		50					
			1.6 V	1.6 V				125			
IBHLO§	$V_I = 0$ to V_{CC}		1.95 V	1.95 V				200		μА	
			2.7 V	2.7 V				300			
			3.6 V	3.6 V				500			
			1.2 V	1.2 V		-50					
			1.6 V	1.6 V				-125			
I _{BHHO} ¶	$V_I = 0$ to V_{CC}		1.95 V	1.95 V				-200		μΑ	
				2.7 V				-300		.	
			3.6 V	3.6 V				-500			

The bus-hold circuit can sink at least the minimum low sustaining current at V_{IL} max. I_{BHL} should be measured after lowering V_{IN} to GND and then raising it to V_{IL} max.

NOTE 9: $V_{\mbox{CCO}}$ is the $V_{\mbox{CC}}$ associated with the output port.



[‡] The bus-hold circuit can source at least the minimum high sustaining current at V_{IH} min. I_{BHH} should be measured after raising V_{IN} to V_{CC} and then lowering it to V_{IH} min.

[§] An external driver must source at least I_{BHLO} to switch this node from low to high.

[¶] An external driver must sink at least I_{BHHO} to switch this node from high to low.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Notes 10 and 11) (continued)

		TEST SOURIE	10110	.,	.,	T,	4 = 25°C	;	-40°C to	85°C	
PARA	METER	TEST CONDIT	IONS	VCCA	VCCB	MIN	TYP	MAX	MIN	MAX	UNIT
1	A port	V _I or V _O = 0 to 3.6 V		0 V	0 to 3.6 V		±0.1	±2.5		±5	^
l _{off}	B port			0 to 3.6 V	0 V		±0.1	±2.5		±5	μΑ
	A or B ports	$V_O = V_{CCO}$ or GND,	OE = V _{IH}	3.6 V	3.6 V		±0.5	±2.5		±5	_
loz†	B port	V _I = V _{CCI} or GND	OE = don't	0 V	3.6 V					±5	μА
	A port		care	3.6 V	0 V					±5	
	-		_	1.2 V to 3.6 V	1.2 V to 3.6 V					40	
ICCA		$V_I = V_{CCI}$ or GND,	$I_O = 0$	0 V	3.6 V					-5	μΑ
				3.6 V	0 V					40	
				1.2 V to 3.6 V	1.2 V to 3.6 V					40	
ICCB		$V_I = V_{CCI}$ or GND,	$I_O = 0$	0 V	3.6 V					40	μΑ
				3.6 V	0 V					-5	
ICCA	+ ICCB	$V_I = V_{CCI}$ or GND,	IO = 0	1.2 V to 3.6 V	1.2 V to 3.6 V					75	μΑ
C _i	Control inputs	$V_I = 3.3 \text{ V or GND}$		3.3 V	3.3 V		3.5				pF
C _{io}	A or B ports	$V_O = 3.3 \text{ V or GND}$		3.3 V	3.3 V		7				pF

[†] For I/O ports, the parameter IOZ includes the input leakage current.

NOTES: 10. V_{CCO} is the V_{CC} associated with the output port.

11. V_{CCI} is the V_{CC} associated with the input port.

switching characteristics over recommended operating free-air temperature range, $V_{CCA} = 1.2 \text{ V}$ (see Figure 1)

24244555	FROM	то	V _{CCB} = 1.2 V	V _{CCB} = 1.5 V	V _{CCB} = 1.8 V	V _{CCB} = 2.5 V	V _{CCB} = 3.3 V		
PARAMETER	(INPUT)	(OUTPUT)	TYP	TYP	TYP	TYP	TYP	UNIT	
t _{PLH}		_	4.1	3.3	3	2.8	3.2		
t _{PHL}	Α	В	4.1	3.3	3	2.8	3.2	ns	
tPLH	В	Δ.	4.4	4	3.8	3.6	3.5		
t _{PHL}	В	Α	4.4	4	3.8	3.6	3.5	ns	
t _{PZH}	ŌĒ	Δ.	6.4	6.4	6.4	6.4	6.4		
tPZL	OE	Α	6.4	6.4	6.4	6.4	6.4	ns	
^t PZH	ŌĒ		6	4.6	4	3.4	3.2		
t _{PZL}	OE	В	6	4.6	4	3.4	3.2	ns	
t _{PHZ}	ŌĒ		6.6	6.6	6.6	6.6	6.8		
tPLZ	OE	Α	6.6	6.6	6.6	6.6	6.8	ns	
t _{PHZ}	ŌĒ		6	4.9	4.9	4.2	5.3		
t _{PLZ}	OE	В	6	4.9	4.9	4.2	5.3	ns	

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switching characteristics over recommended operating free-air temperature range, V_{CCA} = 1.5 V \pm 0.1 V (see Figure 1)

PARAMETER FROM (INPUT)		TO (OUTPUT)	V _{CCB} = 1.2 V	V _{CCB} =		V _{CCB} = ± 0.1		V _{CCB} =		V _{CCB} =		UNIT
	(INPUI)	(001701)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
tPLH	٨	В	3.6	0.5	6.2	0.5	5.2	0.5	4.1	0.5	3.7	
t _{PHL}	Α	В	3.6	0.5	6.2	0.5	5.2	0.5	4.1	0.5	3.7	ns
tPLH	6	Δ.	3.3	0.5	6.2	0.5	5.9	0.5	5.6	0.5	5.5	
t _{PHL}	В	Α	3.3	0.5	6.2	0.5	5.9	0.5	5.6	0.5	5.5	ns
^t PZH	ŌĒ		4.3	1	10.1	1	10.1	1	10.1	1	10.1	
tPZL	OE	Α	4.3	1	10.1	1	10.1	1	10.1	1	10.1	ns
^t PZH	ŌĒ		5.6	1	10.1	0.5	8.1	0.5	5.9	0.5	5.2	
tPZL	OE	В	5.6	1	10.1	0.5	8.1	0.5	5.9	0.5	5.2	ns
t _{PHZ}	ŌĒ	Δ.	4.5	1.5	9.1	1.5	9.1	1.5	9.1	1.5	9.1	
tPLZ	OE	Α	4.5	1.5	9.1	1.5	9.1	1.5	9.1	1.5	9.1	ns
t _{PHZ}	ŌĒ		5.5	1.5	8.7	1.5	7.5	1	6.5	1	6.3	
t _{PLZ}	OE	В	5.5	1.5	8.7	1.5	7.5	1	6.5	1	6.3	ns

switching characteristics over recommended operating free-air temperature range, V_{CCA} = 1.8 V \pm 0.15 V (see Figure 1)

PARAMETER	PARAMETER FROM (INPUT) (V _{CCB} = 1.2 V	V _{CCB} =		V _{CCB} = ± 0.1		V _{CCB} = ± 0.2		V _{CCB} = ± 0.3		UNIT
	(INPUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t _{PLH}	٨		3.4	0.5	5.9	0.5	4.8	0.5	3.7	0.5	3.3	
tPHL	Α	В	3.4	0.5	5.9	0.5	4.8	0.5	3.7	0.5	3.3	ns
t _{PLH}	В		3	0.5	5.2	0.5	4.8	0.5	4.5	0.5	4.4	
t _{PHL}	В	А	3	0.5	5.2	0.5	4.8	0.5	4.5	0.5	4.4	ns
t _{PZH}	ŌĒ		3.4	1	7.8	1	7.8	1	7.8	1	7.8	
tPZL	OE	Α	3.4	1	7.8	1	7.8	1	7.8	1	7.8	ns
t _{PZH}	ŌĒ	В	5.4	1	9.2	0.5	7.4	0.5	5.3	0.5	4.5	
tPZL	OE	В	5.4	1	9.2	0.5	7.4	0.5	5.3	0.5	4.5	ns
t _{PHZ}	<u></u>		4.2	1.5	7.7	1.5	7.7	1.5	7.7	1.5	7.7	
t _{PLZ}	ŌĒ	А	4.2	1.5	7.7	1.5	7.7	1.5	7.7	1.5	7.7	ns
t _{PHZ}	ŌĒ		5.2	1.5	8.4	1.5	7.1	1	5.9	1	5.7	
tPLZ	OE	В	5.2	1.5	8.4	1.5	7.1	1	5.9	1	5.7	ns

SN74AVCH24T245 **24-BIT DUAL-SUPPLY BUS TRANSCEIVER** WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS SCES588B - AUGUST 2004 - REVISED MARCH 2005

switching characteristics over recommended operating free-air temperature range, $V_{CCA} = 2.5 V \pm 0.2 V$ (see Figure 1)

PARAMETER	FROM (INPUT)	TO	V _{CCB} = 1.2 V	V _{CCB} = 1.5 V ± 0.1 V		V _{CCB} = 1.8 V ± 0.15 V		V _{CCB} = 2.5 V ± 0.2 V		V _{CCB} = 3.3 V ± 0.3 V		UNIT	
		(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX		
^t PLH	Δ.		3.2	0.5	5.6	0.5	4.5	0.5	3.3	0.5	2.8		
^t PHL	А	В	3.2	0.5	5.6	0.5	4.5	0.5	3.3	0.5	2.8	ns	
^t PLH	В		2.6	0.5	4.1	0.5	3.7	0.5	3.3	0.5	3.2		
^t PHL	В	Α	2.6	0.5	4.1	0.5	3.7	0.5	3.3	0.5	3.2	ns	
^t PZH	ŌĒ		2.5	0.5	5.3	0.5	5.3	0.5	5.3	0.5	5.3		
t _{PZL}	OE	А	2.5	0.5	5.3	0.5	5.3	0.5	5.3	0.5	5.3	ns	
^t PZH	ŌĒ		5.2	0.5	9.4	0.5	7.3	0.5	5.1	0.5	4.5		
tPZL		В	5.2	0.5	9.4	0.5	7.3	0.5	5.1	0.5	4.5	ns	
^t PHZ	ŌĒ		3	1	6.1	1	6.1	1	6.1	1	6.1		
t _{PLZ}		OE	Α	3	1	6.1	1	6.1	1	6.1	1	6.1	ns
^t PHZ	ŌĒ	ŌĒ		5	1	7.9	1	6.6	1	6.1	1	5.2	
t _{PLZ}			В	5	1	7.9	1	6.6	1	6.1	1	5.2	ns

switching characteristics over recommended operating free-air temperature range, $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (see Figure 1)

PARAMETER	FROM (INPUT)	TO	V _{CCB} = 1.2 V	V _{CCB} = 1.5 V ± 0.1 V		V _{CCB} = 1.8 V ± 0.15 V		V _{CCB} = 2.5 V ± 0.2 V		V _{CCB} = 3.3 V ± 0.3 V		UNIT	
		(INPUT)	(INPUT)	(INPUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN
^t PLH	Δ.	-	3.2	0.5	5.5	0.5	4.4	0.5	3.2	0.5	2.7		
^t PHL	Α	В	3.2	0.5	5.5	0.5	4.4	0.5	3.2	0.5	2.7	ns	
^t PLH	В	۸	2.8	0.5	3.7	0.5	3.3	0.5	2.8	0.5	2.7		
^t PHL		А	2.8	0.5	3.7	0.5	3.3	0.5	2.8	0.5	2.7	ns	
^t PZH	ŌĒ		2.2	0.5	4.3	0.5	4.2	0.5	4.1	0.5	4		
tPZL	OE	Α	2.2	0.5	4.3	0.5	4.2	0.5	4.1	0.5	4	ns	
^t PZH	ŌĒ	В	5.1	0.5	9.3	0.5	7.2	0.5	4.9	0.5	4		
tPZL	OE	В	5.1	0.5	9.3	0.5	7.2	0.5	4.9	0.5	4	ns	
^t PHZ	ŌĒ	Δ.	3.4	0.5	5	0.5	5	0.5	5	0.5	5		
t _{PLZ}	OE	Α	3.4	0.5	5	0.5	5	0.5	5	0.5	5	ns	
^t PHZ	ŌĒ	В	4.9	1	7.7	1	6.5	1	5.2	0.5	5		
^t PLZ		B	4.9	1	7.7	1	6.5	1	5.2	0.5	5	ns	

SN74AVCH24T245 24-BIT DUAL-SUPPLY BUS TRANSCEIVER WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS SCES588B - AUGUST 2004 - REVISED MARCH 2005

operating characteristics, $T_A = 25^{\circ}C$

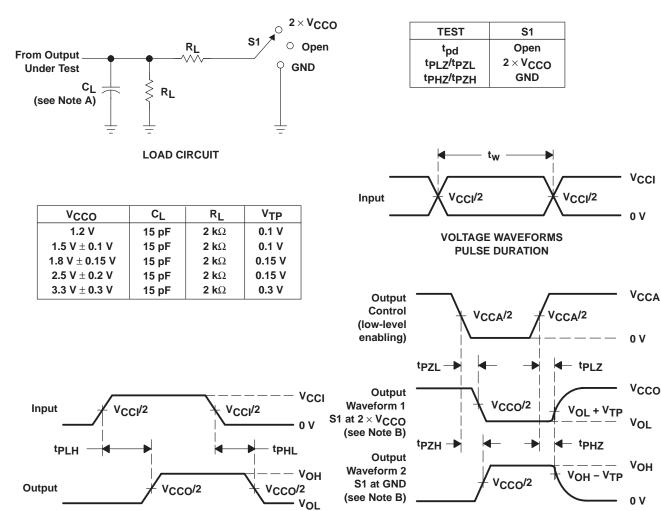
PARAMETER		TEST CONDITIONS	V _{CCB} = 1.2 V V _{CCB} = 1.5 V		V _{CCA} = V _{CCB} = 1.8 V	V _{CCA} = V _{CCB} = 2.5 V	V _{CCA} = V _{CCB} = 3.3 V	UNIT		
			CONDITIONS	TYP	TYP	TYP	TYP	TYP		
	A to B	Outputs enabled		1	1	1	2	2		
Cut	C _{pdA} † B to A	Outputs disabled	C _L = 0, f = 10 MHz,	1	1	1	1	2	pF	
Срад		Outputs enabled	$t_{\Gamma} = t_{f} = 1 \text{ ns}$	19	19	20	21	22		
		Outputs disabled		1	1	1	1	1		
	A to D	Outputs enabled		19	19	20	21	22		
c _{pdB} †	A to B	Outputs disabled	C _L = 0,	1	1	1	1	1	pF	
	D to A	Outputs enabled	f = 10 MHz, $t_r = t_f = 1 \text{ ns}$	1	1	1	2	2	рг	
	B to A	Outputs disabled		1	1	1	1	2		

[†] Power dissipation capacitance per transceiver

VOLTAGE WAVEFORMS

ENABLE AND DISABLE TIMES

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50~\Omega$, $dv/dt \geq$ 1 V/ns, $dv/dt \geq$ 1 V/ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.
- H. VCCI is the VCC associated with the input port.
- I. VCCO is the VCC associated with the output port.

VOLTAGE WAVEFORMS

PROPAGATION DELAY TIMES

Figure 1. Load Circuit and Voltage Waveforms







i.com 16-Aug-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74AVCH24T245GRGR	ACTIVE	BGA MI CROSTA R JUNI OR	GRG	83	1000	TBD	SNPB	Level-1-240C-UNLIM
SN74AVCH24T245ZRGR	ACTIVE	BGA MI CROSTA R JUNI OR	ZRG	83	1000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

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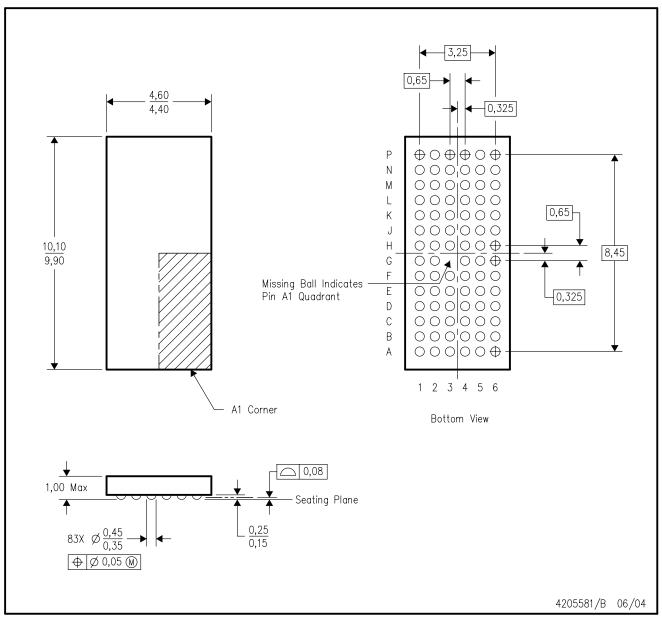
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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GRG (R-PBGA-N83)

PLASTIC BALL GRID ARRAY



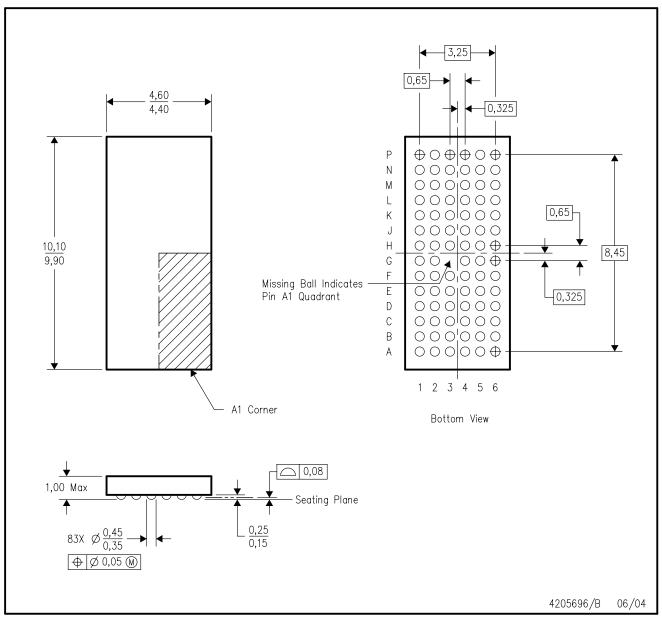
NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. JEDEC MO-225 registration is pending.
- D. This package is tin-lead (SnPb). Refer to the 83 ZRG package (drawing 4205696) for lead-free.



ZRG (R-PBGA-N83)

PLASTIC BALL GRID ARRAY



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. JEDEC MO-225 registration is pending.
- D. This package is lead-free. Refer to the 83 GRG package (drawing 4205581) for tin-lead (SnPb).



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